



Peak EMI Reducing Solution

Features

- Generates an EMI optimized clock signal at the output.
- Integrated loop filter components.
- Operates with a 3.3V / 2.5V supply.
- Operating current less than 6mA.
- CMOS design.
- Input frequency range: 13MHz to 30MHz for 2.5V
13MHz to 30MHz for 3.3V
- Generates a 1X low EMI spread spectrum clock of the input frequency.
- Frequency deviation: -1.25% @ 22MHz.
- Available in 6L-TSOP (6L-TSOT-23) packages.

Product Description

The ASM3P2872A is a versatile spread spectrum frequency modulator designed specifically for a wide range of clock frequencies. The ASM3P2872A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of all clock dependent signals. The ASM3P2872A allows significant system cost savings by reducing the number of circuit board layers, ferrite beads and shielding that are traditionally required to pass EMI regulations.

The ASM3P2872A uses the most efficient and optimized modulation profile approved by the FCC and is implemented by using a proprietary all digital method.

The ASM3P2872A modulates the output of a single PLL in order to “spread” the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called ‘spread spectrum clock generation.’

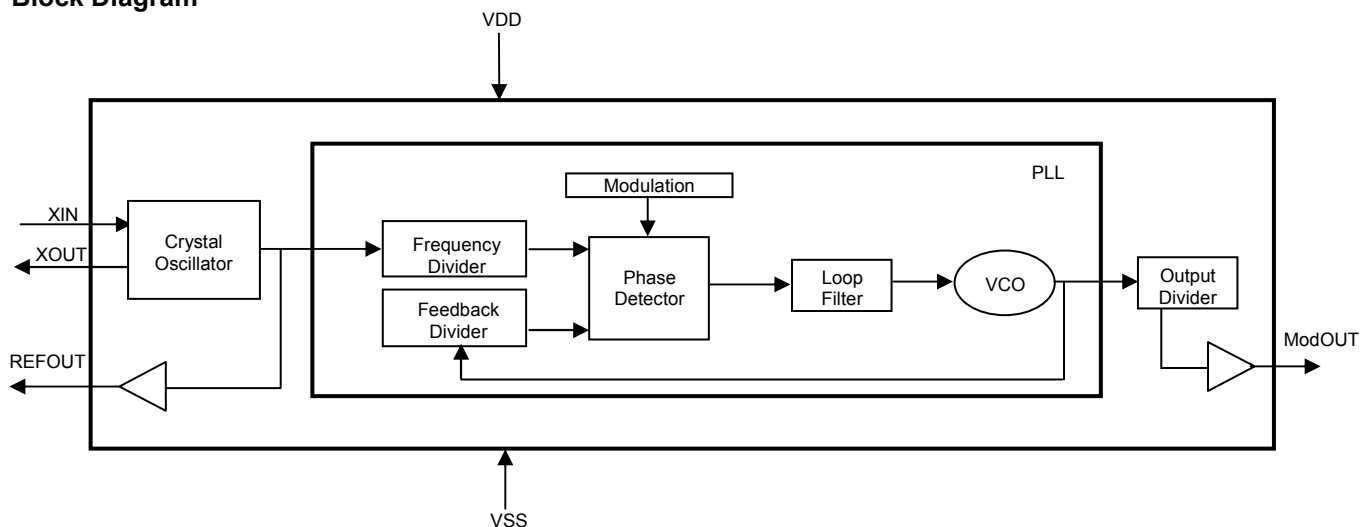
Applications

The ASM3P2872A is targeted towards all portable devices like MP3 players, Notebooks and digital still cameras.

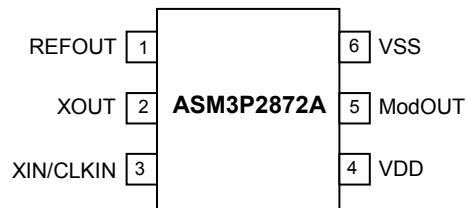
Key Specifications

Description	Specification
Supply voltages	VDD = 3.3V / 2.5V
Cycle-to-Cycle Jitter	±200pS (Typ)
Output Duty Cycle	45/55% (worst case)
Modulation Rate Equation	$F_{IN}/640$
Frequency Deviation	-1.25% @ 22MHz

Block Diagram



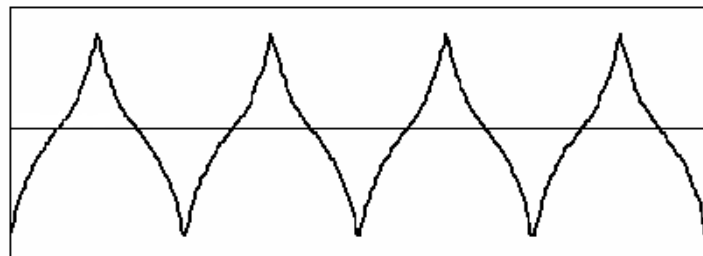
Pin Configuration (6L-TSOP Package)



Pin Description

Pin#	Pin Name	Type	Description
1	REFOUT	O	Buffered output of the input frequency.
2	XOUT	O	Crystal connection. If using an external reference, this pin must be left unconnected.
3	XIN / CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.
4	VDD	P	Power supply for the entire chip.
5	ModOUT	O	Spread spectrum clock output.
6	VSS	P	Ground connection.

Modulation Profile



Specifications

Description		Specification
Frequency Range	For 2.5V Supply	13MHz < CLKIN < 30MHz
	For 3.3V Supply	13MHz < CLKIN < 30MHz
Modulation Equation		$F_{IN}/640$
Frequency Deviation		-1.25% @ 22MHz

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
VDD, VIN	Voltage on any pin with respect to Ground	-0.5 to +4.6	V
T _{STG}	Storage temperature	-65 to +125	°C
T _s	Max. Soldering Temperature (10 sec)	260	°C
T _J	Junction Temperature	150	°C
T _{DV}	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV
Note: These are stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.			

Operating Conditions

Parameter	Description	Min	Max	Unit
VDD	Supply Voltage	2.375	3.6	V
T _A	Operating Temperature (Ambient Temperature)	0	70	°C
C _L	Load Capacitance		15	pF
C _{IN}	Input Capacitance		7	pF

DC Electrical Characteristics for 2.5V Supply

Symbol	Parameter	Min	Typ	Max	Unit
V _{IL}	Input low voltage	VSS-0.3		0.8	V
V _{IH}	Input high voltage	2.0		VDD+0.3	V
I _{IL}	Input low current			-35	μA
I _{IH}	Input high current			35	μA
I _{XOL}	XOUT output low current (@ 0.5V, VDD = 2.5V)		3		mA
I _{XOH}	XOUT output high current (@ 1.8V, VDD = 2.5V)		3		mA
V _{OL}	Output low voltage (VDD = 2.5 V, I _{OL} = 8mA)			0.6	V
V _{OH}	Output high voltage (VDD = 2.5 V, I _{OH} = 8mA)	1.8			V
I _{DD}	Static supply current ¹		1.1		mA
I _{CC}	Dynamic supply current (2.5V, 30MHz and with no load)		4.0		mA
VDD	Operating voltage	2.375	2.5	2.625	V
t _{ON}	Power-up time (first locked cycle after power-up)			5	mS
Z _{OUT}	Output impedance		50		Ω
Note: 1. XIN / CLKIN pin is pulled low.					

AC Electrical Characteristics for 2.5V Supply

Symbol	Parameter	Min	Typ	Max	Unit
CLKIN	Input frequency	13		30	MHz
ModOUT	Output frequency	13		30	MHz
f_d	Frequency Deviation	Input Frequency = 13MHz	-1.85		%
		Input Frequency = 30MHz	-0.9		
t_{LH}^1	Output rise time (measured from 0.7V to 1.7V)	0.7	1.5	1.7	nS
t_{HL}^1	Output fall time (measured from 1.7V to 0.7V)	0.5	0.9	1.1	nS
t_{JC}	Jitter (cycle-to-cycle)		±200		pS
t_D	Output duty cycle	45	50	55	%

Note: 1. t_{LH} and t_{HL} are measured into a capacitive load of 15pF.

DC Electrical Characteristics for 3.3V Supply

Symbol	Parameter	Min	Typ	Max	Unit
V_{IL}	Input low voltage	VSS-0.3		0.8	V
V_{IH}	Input high voltage	2.0		VDD+0.3	V
I_{IL}	Input low current			-35	μA
I_{IH}	Input high current			35	μA
I_{XOL}	XOUT output low current (@ 0.4V, VDD = 3.3V)		3		mA
I_{XOH}	XOUT output high current (@ 2.5V, VDD = 3.3V)		3		mA
V_{OL}	Output low voltage (VDD = 3.3 V, I_{OL} = 8mA)			0.4	V
V_{OH}	Output high voltage (VDD = 3.3 V, I_{OH} = 8mA)	2.5			V
I_{DD}	Static supply current ¹		1.2		mA
I_{CC}	Dynamic supply current (3.3V, 30MHz and with no load)		5.5		mA
VDD	Operating voltage	2.7	3.3	3.6	V
t_{ON}	Power-up time (first locked cycle after power-up)			5	mS
Z_{OUT}	Output impedance		45		Ω

Note: 1. XIN / CLKIN pin is pulled low.

AC Electrical Characteristics for 3.3V Supply

Symbol	Parameter	Min	Typ	Max	Unit
CLKIN	Input frequency	13		30	MHz
ModOUT	Output frequency	13		30	MHz
f_d	Frequency Deviation	Input Frequency = 13MHz		-1.85	%
		Input Frequency = 30MHz		-0.9	
t_{LH}^1	Output rise time (measured from 0.8 to 2.0V)	0.5	1.4	1.7	nS
t_{HL}^1	Output fall time (measured at 2.0V to 0.8V)	0.4	0.9	1.1	nS
t_{JC}	Jitter (cycle-to-cycle)		±200		pS
t_D	Output duty cycle	45	50	55	%

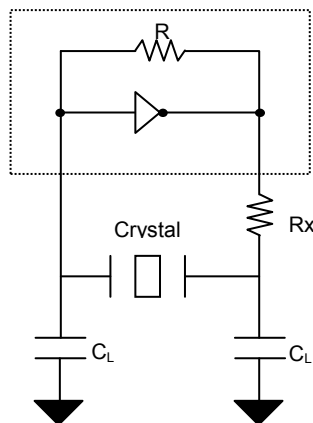
Note: 1. t_{LH} and t_{HL} are measured into a capacitive load of 15pF.

Typical Crystal Specifications

Fundamental AT cut parallel resonant crystal	
Nominal frequency	14.31818MHz
Frequency tolerance	± 50 ppm or better at 25°C
Operating temperature range	-25°C to +85°C
Storage temperature	-40°C to +85°C
Load capacitance(C_P)	18pF
Shunt capacitance	7pF maximum
ESR	25 Ω

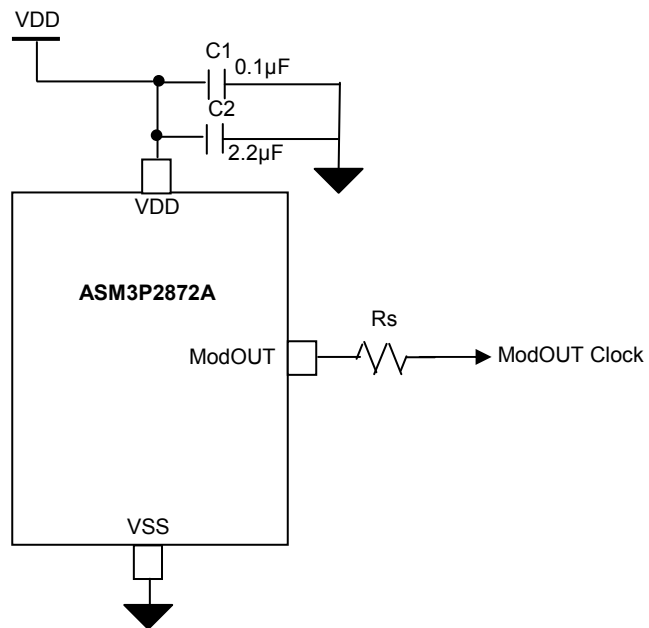
Note: Note: C_L is Load Capacitance and R_x is used to prevent oscillations at overtone frequency of the Fundamental frequency.

Typical Crystal Interface Circuit



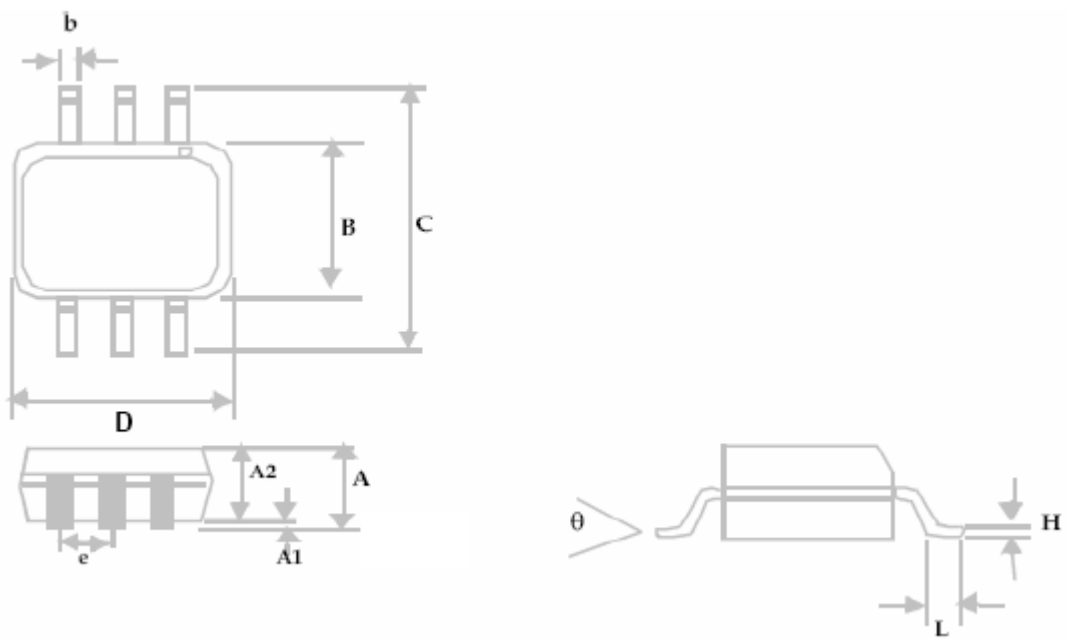
$C_L = 2 * (C_P - C_S)$,
Where C_P = Load capacitance of crystal
 C_S = Stray capacitance due to C_{IN} , PCB, Trace etc.

Typical Application Schematic



Package Information

6L-TSOP Package




Symbol	Dimensions			
	Inches		Millimeters	
	Min	Max	Min	Max
A		0.04		1.00
A1	0.00	0.004	0.00	0.10
A2	0.033	0.036	0.84	0.90
b	0.012	0.02	0.30	0.50
H	0.005 BSC		0.127 BSC	
D	0.114 BSC		2.90 BSC	
B	0.06 BSC		1.60 BSC	
e	0.0374 BSC		0.950 BSC	
C	0.11 BSC		2.80 BSC	
L	0.0118	0.02	0.30	0.50
θ	0°	4°	0°	4°

Ordering Information

Part Number	Marking	Package Type	Temperature
ASM3P2872AF-06OR	B4L	6L-TSOP (6L-TSOT-23), TAPE & REEL, Pb Free	0°C to +70°C

A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-free.

ON Semiconductor and  are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. U.S. Patent Pending; Timing-Safe and Active Bead are trademarks of PulseCore Semiconductor, a wholly owned subsidiary of ON Semiconductor. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855
Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5773-3850

ON Semiconductor Website:
www.onsemi.com

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative